



Product Summary (@ T_A = +25°C)

V _{RRM} (V)	I _O (A)	V _F (MAX) (V)	Ι _{R(MAX)} (μΑ)
600	1	1.7	5

Description

The SF1JWF-7 is a rectifier packaged in the SOD123F package and is suited as a boost diode in power factor correction circuitry. For use in secondary rectification and freewheeling for super-fast switching speed AC-AC and DC-DC converters in high-temperature conditions for consumer applications.

Applications

- Flat Panel Display
- Switching Power Supplies/Chargers
- LED Lighting
- Freewheeling Diode

1.0A SURFACE MOUNT SUPER-FAST RECTIFIER

Features and Benefits

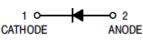
- Soft, Super-Fast Switching Capability for High Efficiency
- Low Leakage Current
- Glass Passivated for High Reliability
- Small Form Factor Package
- High Reverse Breakdown Voltage V_{RRM}
- Low Forward Voltage, Low Power Loss
- Lead-Free Finish & RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: SOD123F
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Polarity: Cathode Band
- Weight: 0.016 grams (Approximate)

SOD123F





Schematic View

Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
SF1JWF-7	Commercial	SOD123F	3,000/Tape & Reel

1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



E6 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: E = 2017) M = Month (ex: 9 = September)

Date Code Key

Notes:

Year		2017	2018	20)19	2020	202	21	2022	2023	}	2024
Code		E	F	(G	Н			J	K		L
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

Characteristic		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} Vr	600	V
RMS Reverse Voltage		V _{R(RMS)}	420	V
Average Rectified Output Current	$@T_A = +25^{\circ}C$	lo	1	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed o	I _{FSM}	30	А	

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Case	R _{eJC}	58	°C/W
Typical Thermal Resistance Junction to Ambient (Note 6)	R _{OJA}	95	°C/W
Power Dissipation (Note 6)	PD	1.7	W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

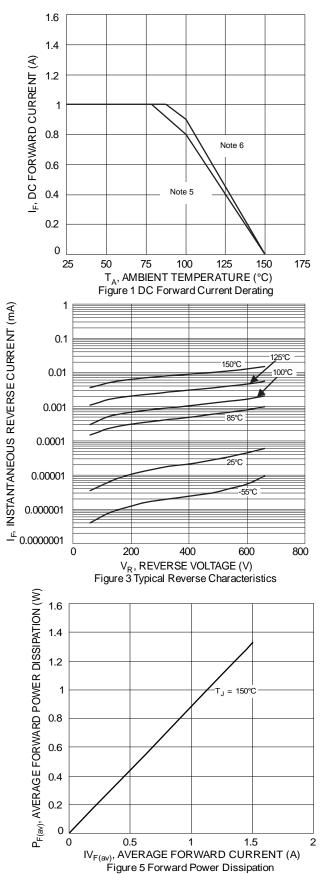
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V _{(BR)R}	600	—	—	V	I _R = 10μA
Forward Voltage	VF	_	1.4 1.1	1.7	V	I _F = 1A, T _J = +25°C I _F = 1A, T _J = +125°C
Reverse Leakage Current (Note 7)	I _R	_	0.3 0.2	5	μA mA	V _R = 600V, T _J = +25°C V _R = 600V, T _J = +125°C
Reverse Recovery Time	t _{RR}		30	35	ns	$I_F = 0.5A, I_R = 1.0A, I_{RR} = 0.25A$
Total Capacitance	CT	_	7	_	pF	$V_R = 4.0V_{DC}$, f = 1MHz

Device mounted on FR-4 substrate, 0.4" × 0.5", 2oz, single-sided, PCBs with 0.2" × 0.25" copper pad.
 Device mounted on FR-4 substrate, 25.4mm × 25.4mm, 2oz, single-sided, PCBs with 2.1mm × 2.1mm copper pad.
 Short duration pulse test used to minimize self-heating effect.

Notes:



NEW PRODUCT



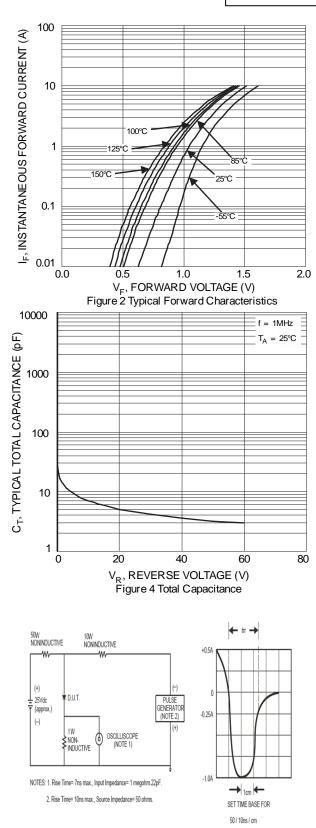
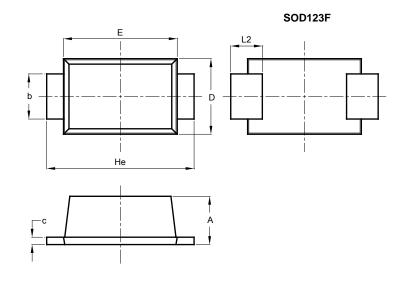


Fig 6. Reverse Recovery Time Characteristic and Test Circuit



Package Outline Dimensions

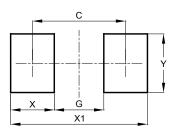
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOD123F							
Dim	Min	Max	Тур				
Α	0.81	1.15	—				
b	0.80	1.05	—				
c	0.05	0.30	-				
D	1.70	1.90	1.80				
т	2.60	2.80	2.70				
He	3.30	3.70	3.50				
L2	0.35	0.85	—				
All D	Dimen	sions	in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SOD123F

Dimensions	Value (in mm)		
С	2.86		
G	1.52		
Х	1.34		
X1	4.20		
Y	1.80		

NEW PRODUCT



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